

Fig. 1

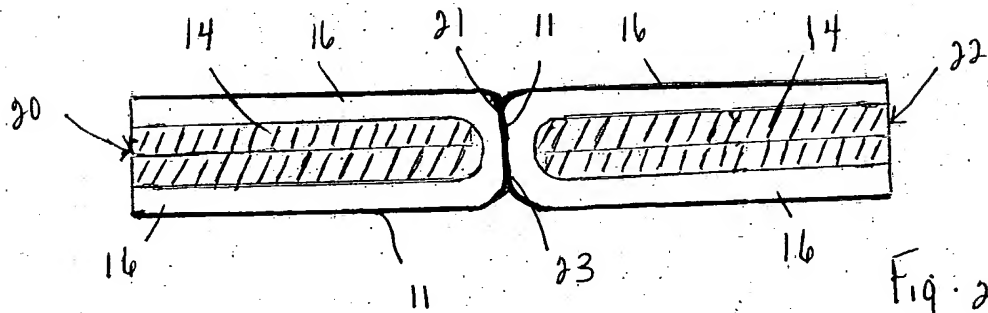


Fig. 2

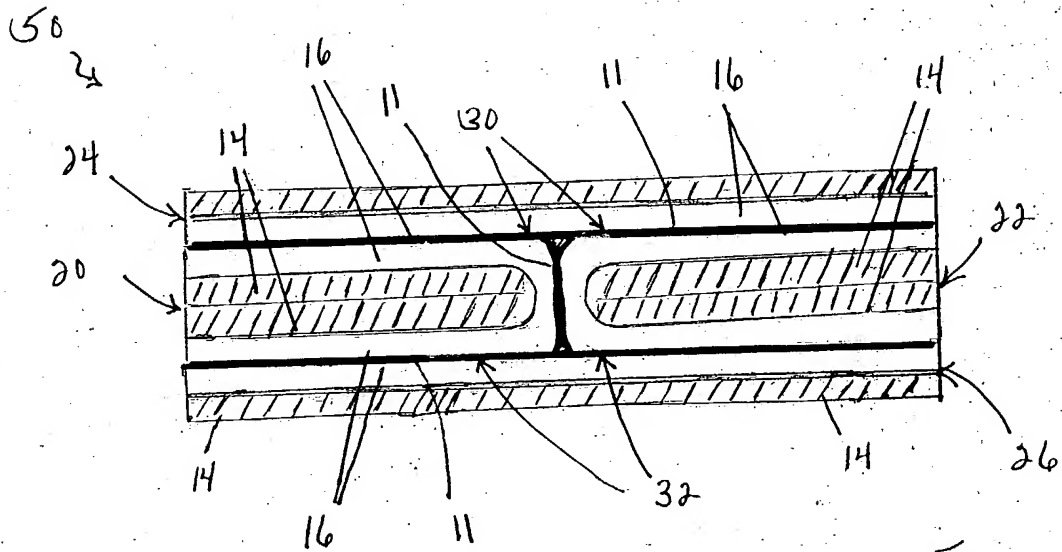


Fig. 3

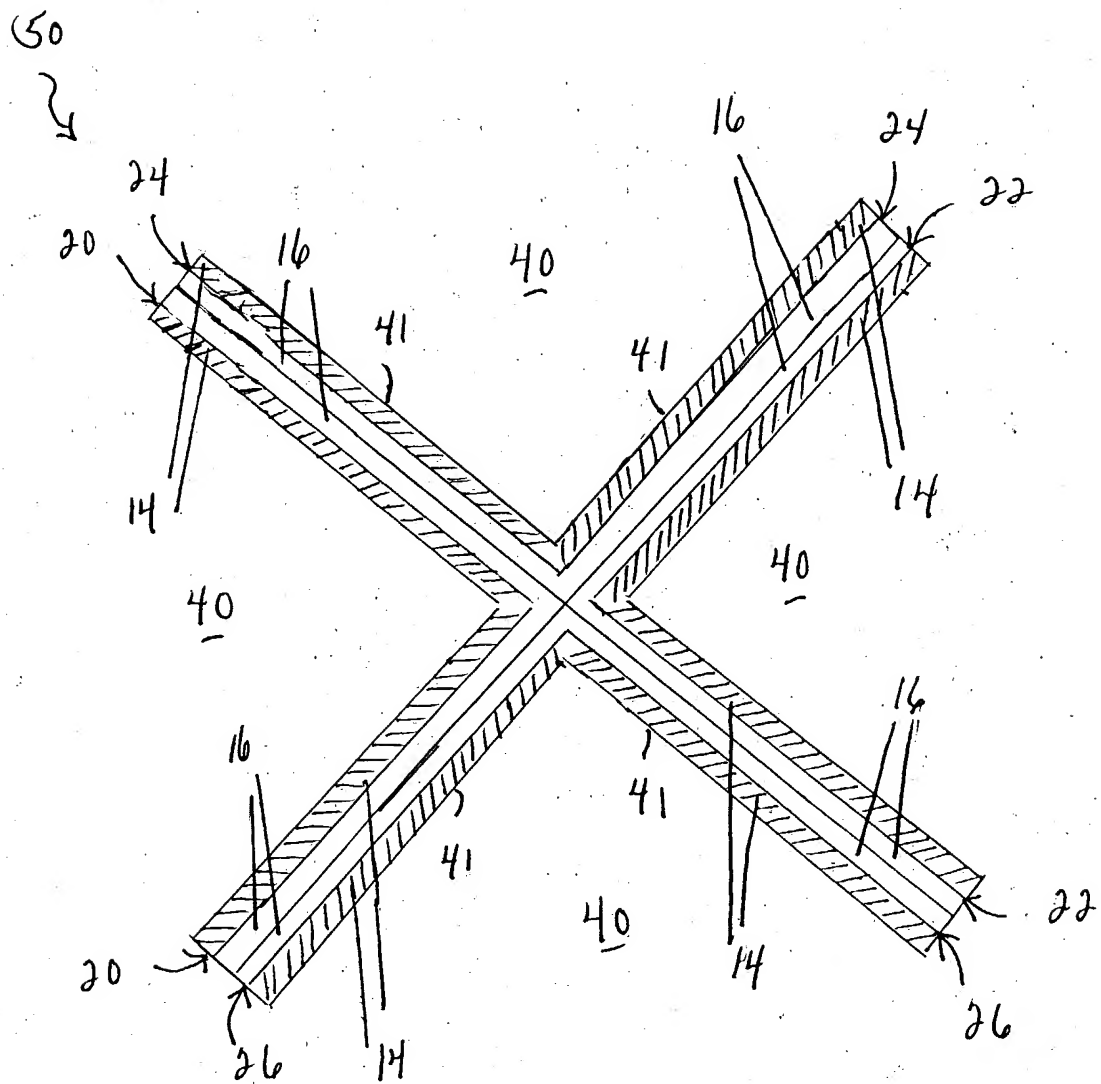


Fig. 4

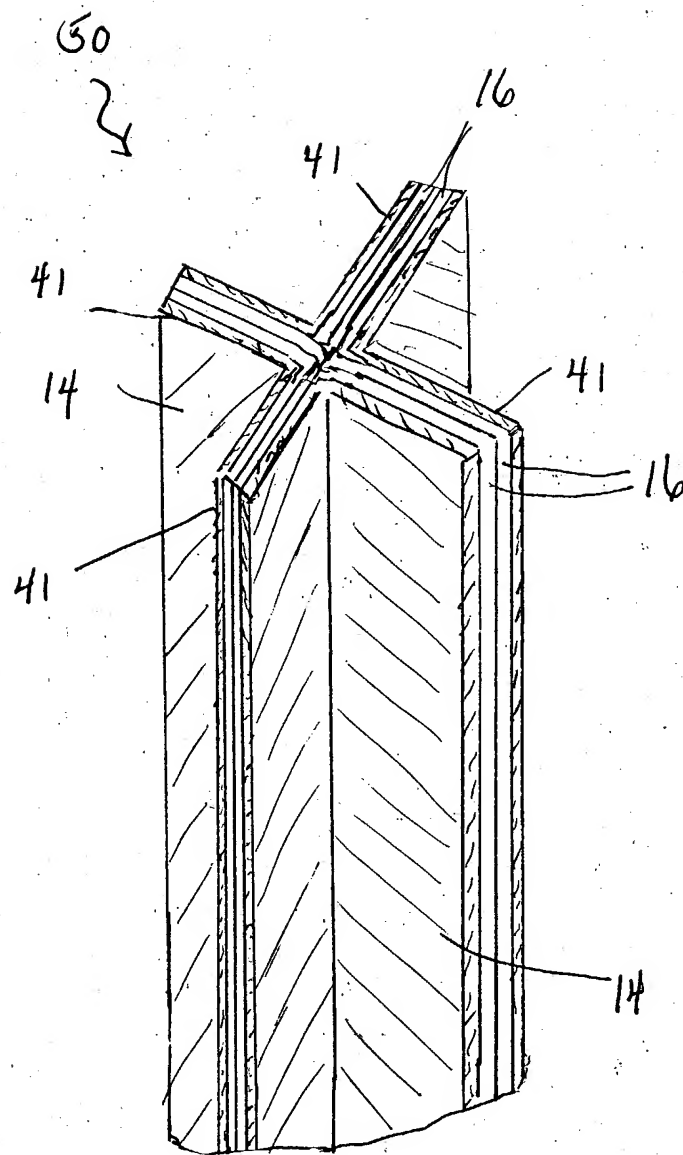


Fig. 5

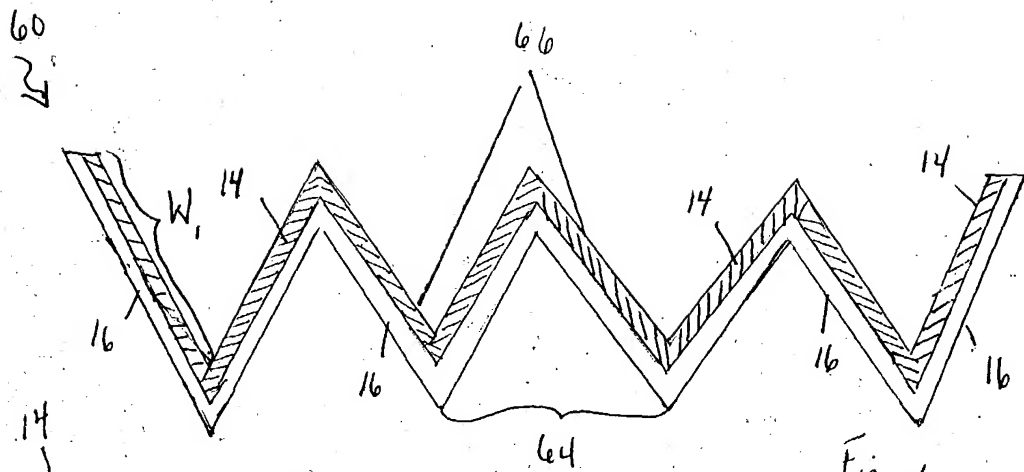


Fig. 6

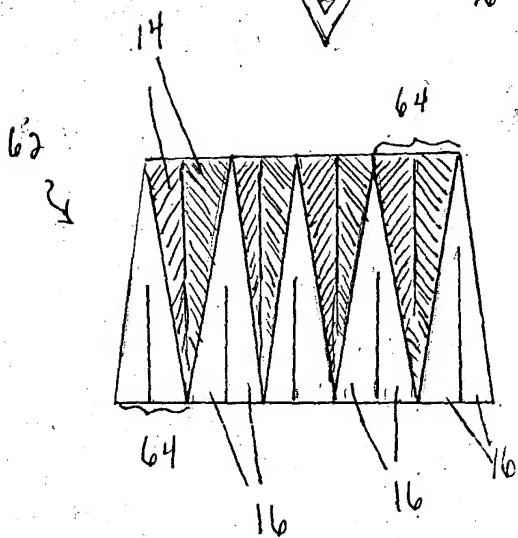


Fig. 7

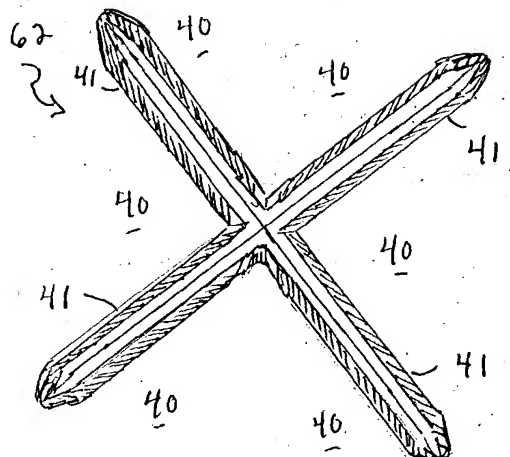


Fig. 8

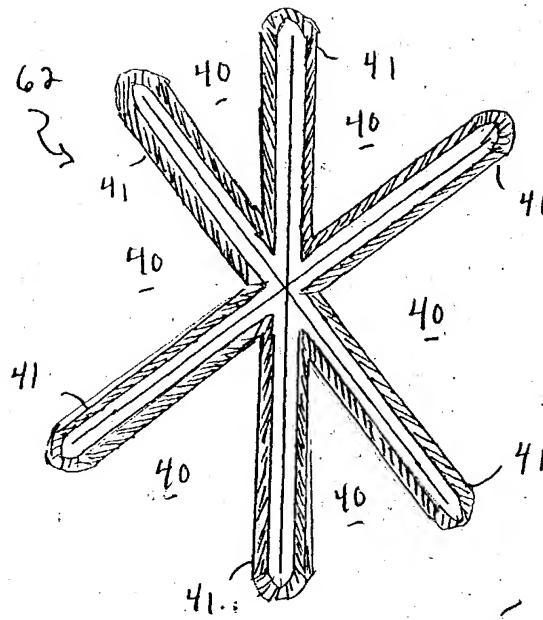


Fig. 9

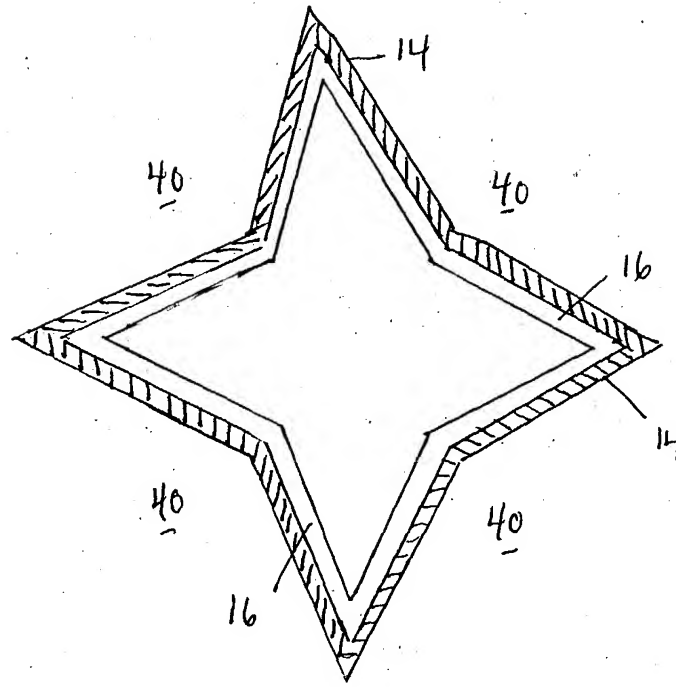


Fig. 10

providing at least one layer of a first material, such as a conductive material, having a length and a width to form a strip of desired dimensions 100

↓
Providing at least one layer of a second material, such as a dielectric material, having a length and a width similar to the layer of conductive material to form a strip of desired dimensions, the dielectric material including a bondable material or fusible film disposed thereon 105

↓
Disposing the conductive layer on the dielectric layer 110

↓
Bonding the conductive and dielectric layers to form a first laminate 115

↓
Folding the first laminate lengthwise to form an interface of the conductive layer 120

↓
Providing a second folded laminate constructed and folded according to steps 100-120 125

↓
Butting a fold of the first folded laminate to a fold of the second folded laminate to align the laminates fold-to-fold 130

↓
Providing a third unfolded laminate and a fourth unfolded laminate each constructed and folded according to steps 100-115 135

↓
Placing the dielectric layer of each of the third and fourth laminates on one of two opposing planes of dielectric material formed by the dielectric layers of the butted first and second folded laminates 140

↓
Fusing the bondable layer or fusible film of the dielectric layers and the butted folds to form a composite 145

↓
Unfolding the composite by opening each interface of the conductive layer to form a single tape configuration having an X-shaped cross-section or profile 150

FIG. 11

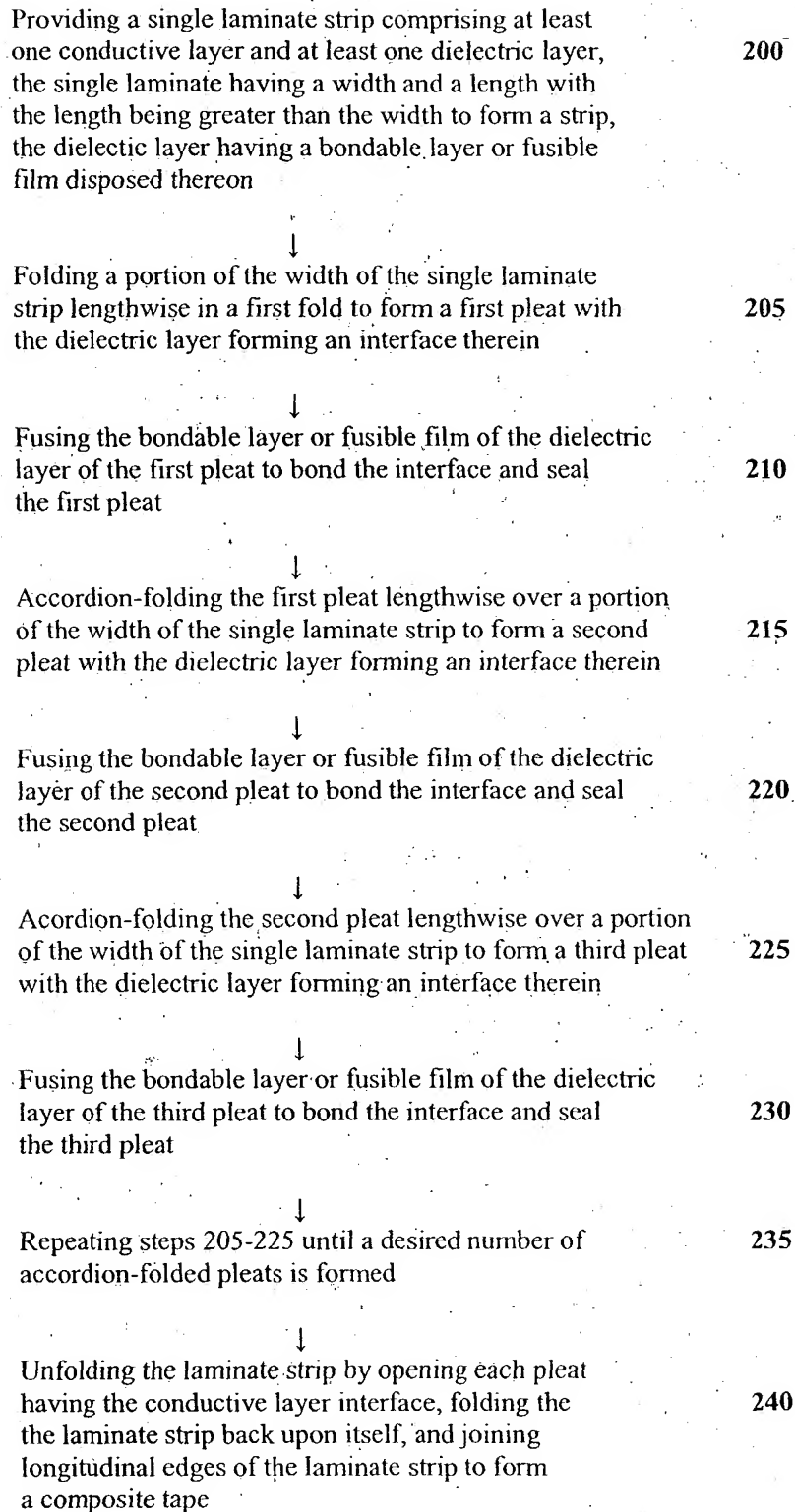
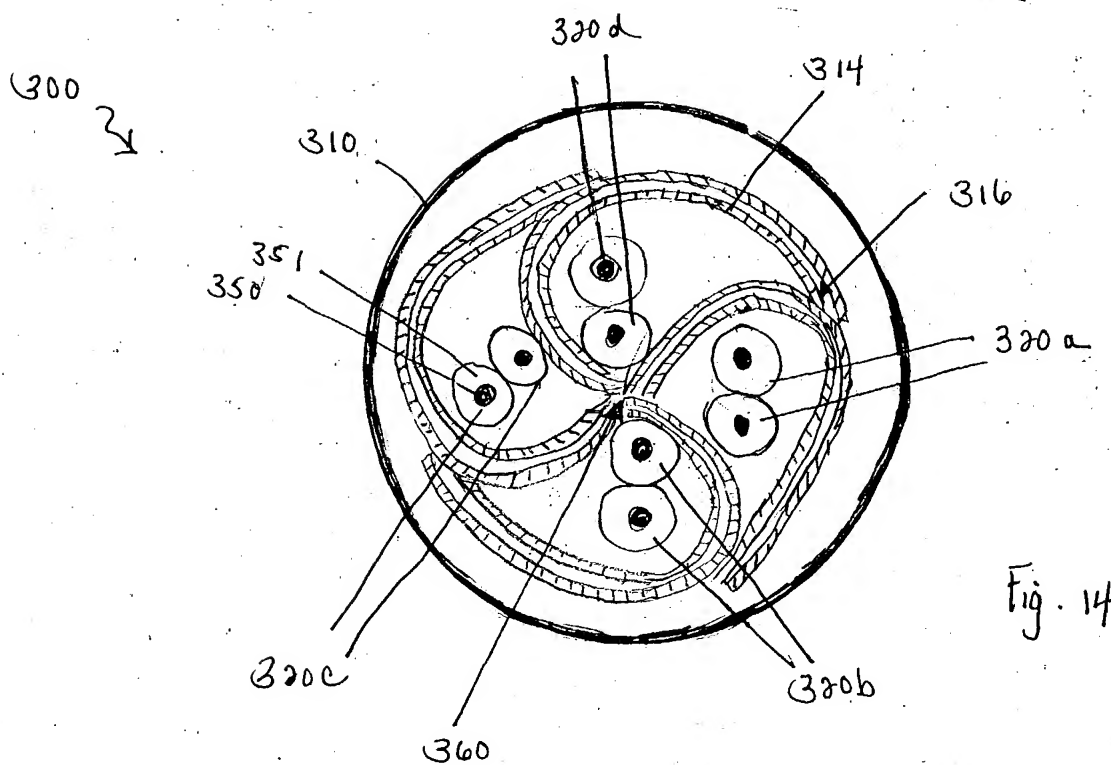
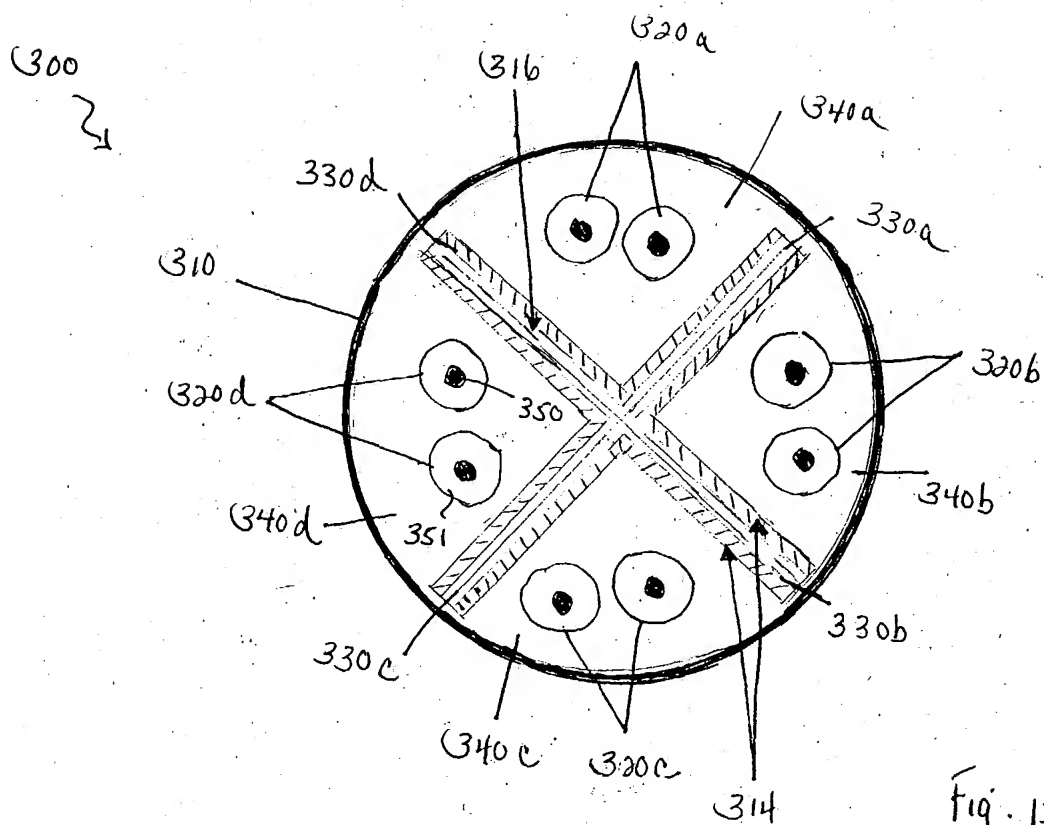


FIG. 12



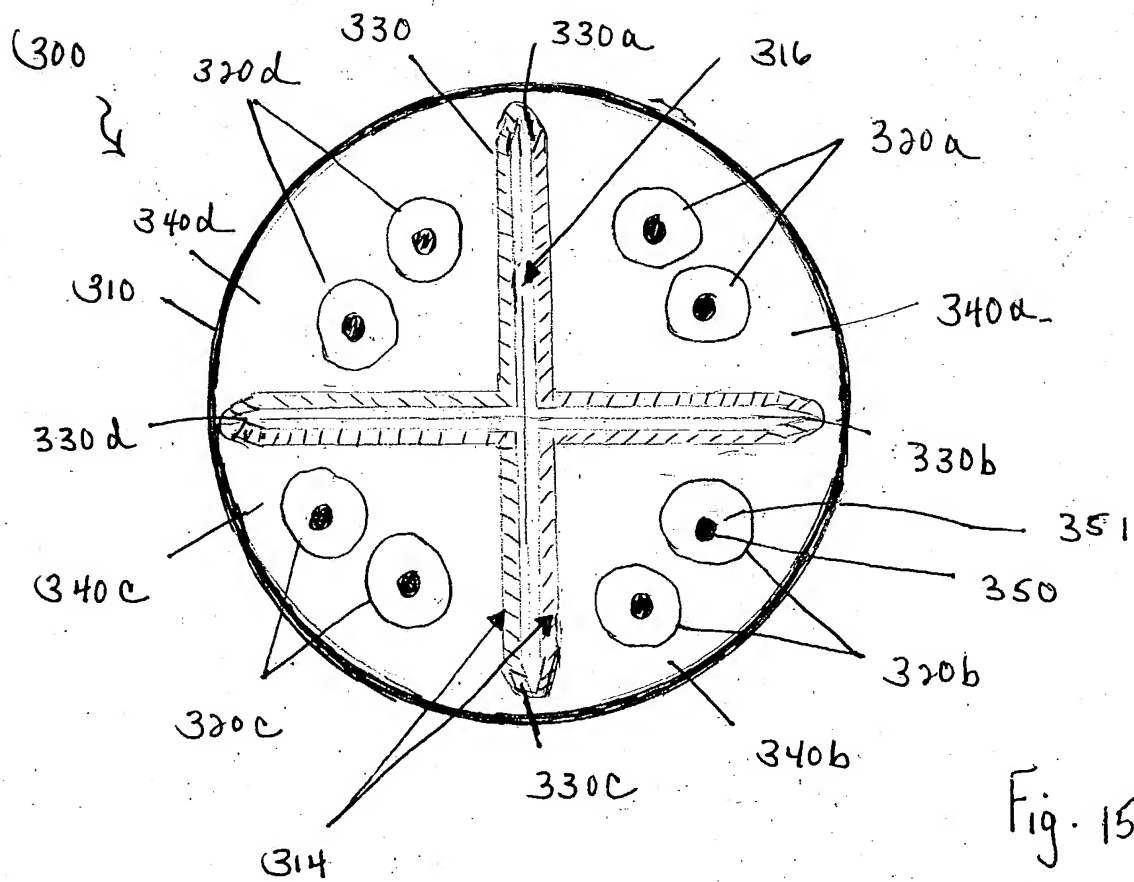


Fig. 15

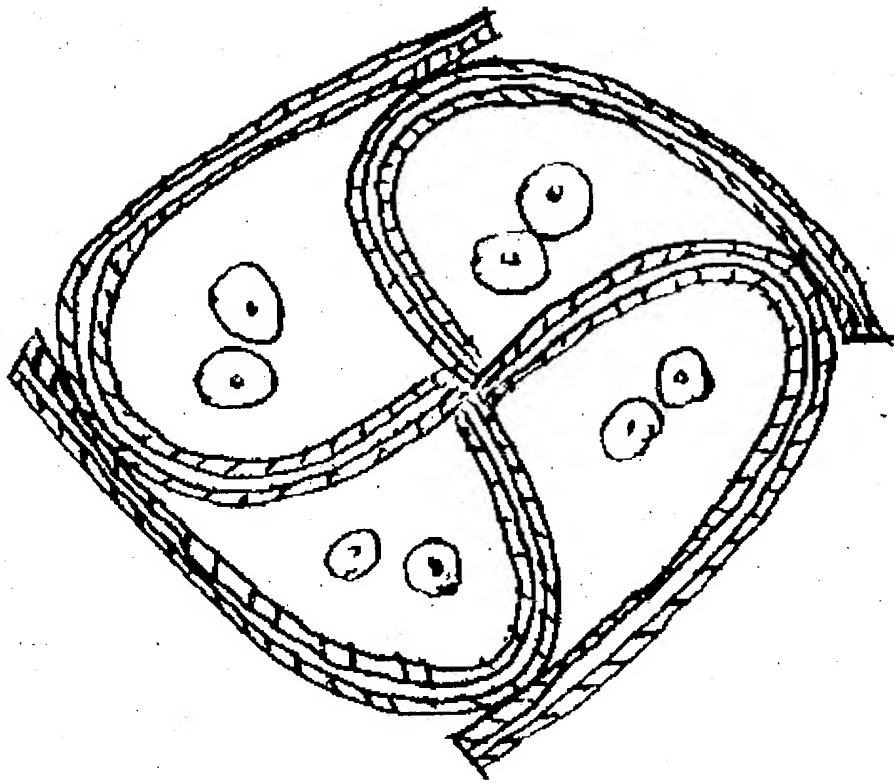


Fig. 16